

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	TLE9271QX V33	**Issued**	07. April 2021
MA#	MA004737218		
Package	PG-VQFN-48-31	**Weight***	129.76 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	3.989	3.07	3.07	30743	30743
leadframe	inorganic material	phosphorus	7723-14-0	0.018	0.01		138	
	non noble metal	zinc	7440-66-6	0.072	0.06		552	
	non noble metal	iron	7439-89-6	1.433	1.10		11045	
	non noble metal	copper	7440-50-8	58.193	44.86	46.03	448484	460219
wire	non noble metal	copper	7440-50-8	0.584	0.45	0.45	4500	4500
encapsulation	organic material	carbon black	1333-86-4	0.184	0.14		1415	
	plastics	epoxy resin	-	7.771	5.99		59886	
	inorganic material	silicondioxide	60676-86-0	53.231	41.02	47.15	410245	471546
leadfinish	non noble metal	tin	7440-31-5	2.596	2.00	2.00	20010	20010
plating	noble metal	silver	7440-22-4	0.614	0.47	0.47	4731	4731
glue	plastics	epoxy resin	-	0.246	0.19		1898	
	noble metal	silver	7440-22-4	0.824	0.64	0.83	6353	8251
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption.

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